

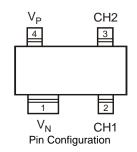


D1213A-02SR

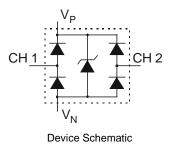
2 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

Features

- IEC 61000-4-2 (ESD): Air ±15kV, Contact ±8kV
- 2 Channels of ESD Protection
- Low Channel Input Capacitance of 0.85pF Typical
- Typically Used at High Speed Ports such as USB 2.0, IEEE1394, Serial ATA, DVI, HDMI, PCI
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability



- **Mechanical Data**
- Case: SOT143
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe
 (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.009 grams (approximate)



Ordering Information (Note 4)

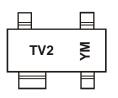
| Part Number | Case | Packaging |
|---------------|--------|------------------|
| D1213A-02SR-7 | SOT143 | 3000/Tape & Reel |
| | | |

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



TV2 = Product Type Marking CodeYM = Date Code MarkingY = Year (ex: Z = 2012)M = Month (ex: 9 = September)

| Date Code Key | | | | | | | | | | | | |
|---------------|-------------------------|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Year | 201 ⁻ | 1 | 2012 | | 2013 | 20 | 14 | 2015 | | 2016 | 2 | 2017 |
| Code | Y | | Z | | А | E | 3 | С | | D | | E |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | Conditions |
|------------------------------------|---------------------------------|--|------|------------------------|
| Operating Supply Voltage | V _P - V _N | 6.0 | V | — |
| DC Voltage at any Channel Input | — | (V _N – 0.5) to (V _P + 0.5) | V | — |
| Peak Pulse Current | IPP | 5 | A | 8/20µs, Per Figure 2 |
| ESD Protection – Contact Discharge | V _{ESD_Contact} | ±8 | kV | Standard IEC 61000-4-2 |
| ESD Protection – Air Discharge | $V_{ESD_{Air}}$ | ±15 | kV | Standard IEC 61000-4-2 |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|------------------|-------------|------|
| Power Dissipation (Note 5) | PD | 400 | mW |
| Thermal Resistance, Junction to Ambient (Note 5) | R _{θJA} | 310 | °C/W |
| Operating and Storage Temperature Range | TJ, TSTG | -65 to +150 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Conditions |
|---------------------------------------|------------------|------|------|------|------|---|
| Operating Supply Voltage | VP | _ | 3.3 | 5.5 | V | — |
| Operating Supply Current (Note 6) | IР | _ | _ | 8.0 | μA | $(V_{P} - V_{N}) = 3.3V$ |
| Channel Leakage Current (Note 6) | I _R | _ | ±0.1 | ±1.0 | μA | $V_P = 5V, V_N = 0V$ |
| Reverse breakdown voltage | V _{BR} | 6.0 | _ | | V | I _R = 1mA |
| Clamping Voltage, Positive Transients | V _{CL1} | _ | 10.0 | _ | V | I _{PP} = 1A, t _p = 8/20μs |
| Clamping Voltage, Negative Transients | V _{CL2} | _ | -1.7 | | V | $I_{PP} = -1A, t_p = 8/20 \mu s$ |
| Forward Voltage for Top Diode | V _{FD1} | 0.60 | 0.80 | 0.95 | V | $I_F = 8mA$, CH1 to V_P or CH2 to V_P |
| Forward Voltage for Bottom Diode | V _{FD2} | 0.60 | 0.80 | 0.95 | V | $I_F = 8mA$, V_N to CH1 or V_N to CH2 |
| Dynamic Resistance | R _{DYN} | _ | 0.9 | | Ω | $I_{PP} = 1A, t_p = 8/20\mu s$ |
| Channel Input Capacitance | CT | _ | 0.85 | 1.2 | pF | $V_{IN} = 1.65V, V_P = 3.3V,$ $V_N = 0V, f = 1MHz$ |

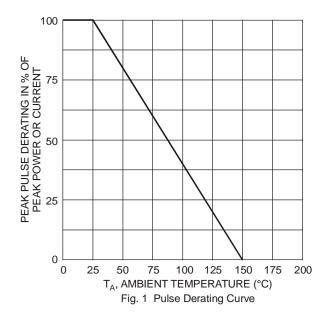
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

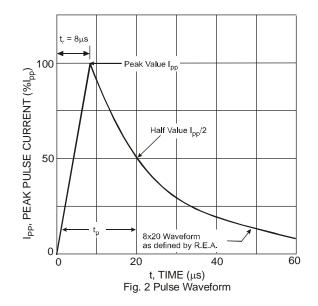
6. Short duration pulse test used to minimize self-heating effect.

7. Measured from CH1 to $\mathsf{V}\mathsf{N}$ or CH2 to $\mathsf{V}\mathsf{N}.$

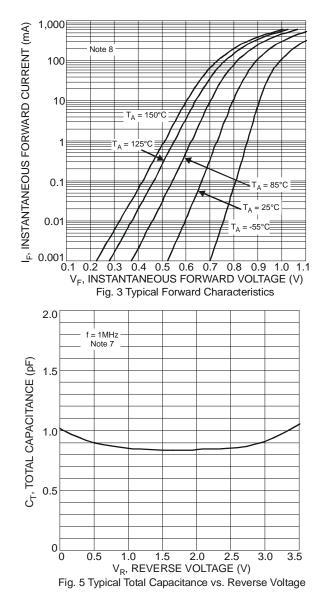
8. Measured from VP to VN.

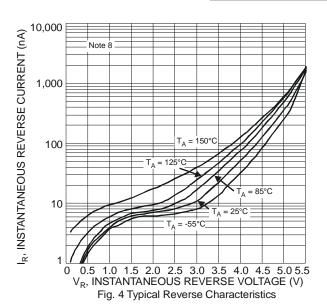
9. For information on the impact of Diodes' USB2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to AN77 at the following URL: http://www.diodes.com/_files/products_appnote_pdfs/AN77.pdf.





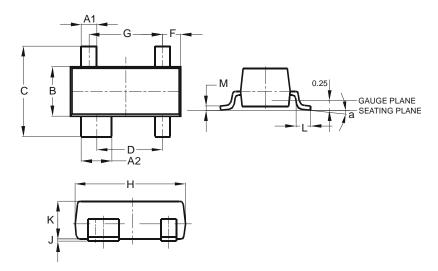






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

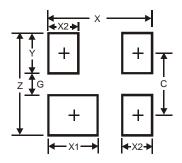


| | SOT143 | | | | | | |
|----------------------|--------|------|-------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| A1 | 0.37 | 0.51 | 0.400 | | | | |
| A2 | 0.77 | 0.93 | 0.800 | | | | |
| в | 1.20 | 1.40 | 1.30 | | | | |
| c | 2.28 | 2.48 | 2.38 | | | | |
| D | 1.58 | 1.83 | 1.72 | | | | |
| F | 0.45 | 0.60 | 0.49 | | | | |
| G | 1.78 | 2.03 | 1.92 | | | | |
| H | 2.80 | 3.00 | 2.90 | | | | |
| J | 0.013 | 0.10 | 0.05 | | | | |
| κ | 0.89 | 1.00 | - | | | | |
| L | 0.46 | 0.60 | 0.50 | | | | |
| М | 0.085 | 0.18 | 0.11 | | | | |
| а | 0° | 8° | - | | | | |
| All Dimensions in mm | | | | | | | |



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.70 |
| G | 1.30 |
| Х | 2.50 |
| X1 | 1.0 |
| X2 | 0.60 |
| Y | 0.70 |
| С | 2.0 |

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